



ROHM Co., Ltd.

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Product/Process Change Notification PCN#: 22119001

This is an announcement of change to products which are currently supplied by ROHM.
ROHM sincerely requires acknowledgment of receipt of this notification within 30 days of the date of this notice. Lack of acknowledgment of this notice within 30 days constitutes acceptance of the change.
Your understanding and cooperation would be highly appreciated.

Issue Date: 2020/6/2

Title of change	
2G SiC DMOSFET wafer size change to 6inch (die, TO220AB)	
Identification of change	
Die: Able to identify by product name. TO220AB: Able to identify by Lot No.	
Detailed description of change	
Before Wafer inch size : 4inch See attachment for detail.	After Wafer inch size : 6inch See attachment for detail.
Affected product(s)	
Manufacture part number	Customer part number
SCT2120AFC	
Reason for change	
Improve production capacity by wafer size enlargement and increase production.	
Anticipated impact on form, fit, function, quality or reliability	
Electrical characteristic and reliability: No change. Marking, Dimensions and Packing: See attachment for detail.	
Planned date for change	
1st/Mar/2020	
Qualification plan schedule, results and samples	
If required, please contact your local ROHM sales office.	
Comments	
Supplier contact	

After acknowledgement of the customer, lack of additional response within 90 day period constitutes acceptance of the change according to JEDEC Standard J-STD-046.